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74VHCT541A

Octal Buffer/Line Driver with 3-STATE Outputs

General Description

The VHCT541A is an advanced high-speed CMOS device fabricated with silicon gate CMOS technology. It achieves the high-speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The VHCT541A is an octal buffer/line driver designed to be employed as memory and address drivers, clock drivers and bus oriented transmitter/receivers.

This device is similar in function to the VHCT244A while providing flow-through architecture (inputs on opposite side from outputs). This pinout arrangement makes this device especially useful as an output port for microprocessors, allowing ease of layout and greater PC board density.

Protection circuits ensure that 0V to 7V can be applied to the input and output (Note 1) pins without regard to the supply voltage. This device can be used to interface 3V to 5V systems and two supply systems such as battery backup. This circuit prevents device destruction due to mismatched supply and input voltages.

Note 1: Outputs in OFF-state.

Features

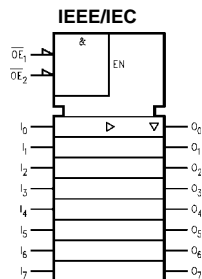
- High Speed: $t_{PD} = 5.5$ ns (typ) at $V_{CC} = 5V$
- Low power dissipation: $I_{CC} = 4$ μA (max) at $T_A = 25^\circ C$
- Power down protection is provided on all inputs and outputs
- Pin and function compatible with 74HCT541

Ordering Code:

| Order Number | Package Number | Package Description |
|---------------|----------------|---|
| 74VHCT541AM | M20B | 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide |
| 74VHCT541ASJ | M20D | Pb-Free 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide |
| 74VHCT541AMTC | MTC20 | 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide |
| 74VHCT541AN | N20A | 20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide |

Surface mount packages are also available on Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.
Pb-Free package per JEDEC J-STD-020B.

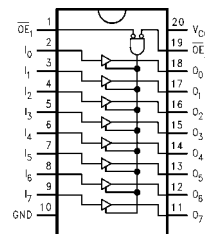
Logic Symbol



Pin Descriptions

| Pin Names | Description |
|------------------------------------|------------------------------|
| $\overline{OE}_1, \overline{OE}_2$ | 3-STATE Output Enable Inputs |
| $I_0 - I_7$ | Inputs |
| $O_0 - O_7$ | 3-STATE Outputs |

Connection Diagram



Truth Table

| Inputs | | | Outputs |
|-------------------|-------------------|---|---------|
| \overline{OE}_1 | \overline{OE}_2 | I | |
| L | L | H | H |
| H | X | X | Z |
| X | H | X | Z |
| L | L | L | L |

H = HIGH Voltage Level
X = Immaterial
L = LOW Voltage Level
Z = High Impedance

Absolute Maximum Ratings (Note 2)

| | |
|---------------------------------------|--------------------------|
| Supply Voltage (V_{CC}) | -0.5V to +7.0V |
| DC Input Voltage (V_{IN}) | -0.5V to +7.0V |
| DC Output Voltage (V_{OUT}) | |
| (Note 3) | -0.5V to 7.0V |
| (Note 4) | -0.5V to $V_{CC} + 0.5V$ |
| Input Diode Current (I_{IK}) | -20 mA |
| Output Diode Current (I_{OK}) | |
| (Note 5) | ±20 mA |
| DC Output Current (I_{OUT}) | ±25 mA |
| DC V_{CC} /GND Current (I_{CC}) | ±75 mA |
| Storage Temperature (T_{STG}) | -65°C to +150°C |
| Lead Temperature (T_L) | |
| (Soldering, 10 seconds) | 260°C |

Recommended Operating Conditions (Note 6)

| | |
|---|----------------|
| Supply Voltage (V_{CC}) | 4.5V to +5.5V |
| Input Voltage (V_{IN}) | 0V to +5.5V |
| Output Voltage (V_{OUT}) | |
| (Note 4) | 0V to V_{CC} |
| (Note 3) | 0V to 5.5V |
| Operating Temperature (T_{OPR}) | -40°C to +85°C |
| Input Rise and Fall Time (t_r, t_f) | |
| $V_{CC} = 5.0V \pm 0.5V$ | 0 ~ 20 ns/V |

Note 2: Absolute Maximum Ratings are values beyond which the device may be damaged or have its useful life impaired. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation outside databook specifications.

Note 3: When Outputs are in OFF-State OR when $V_{CC} = 0V$.

Note 4: HIGH or LOW state I_{OUT} absolute maximum rating must be observed.

Note 5: $V_{OUT} < GND, V_{OUT} > V_{CC}$ (Outputs Active).

Note 6: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

| Symbol | Parameter | V_{CC} (V) | $T_A = 25^\circ C$ | | | $T_A = -40^\circ C$ to $+85^\circ C$ | | Units | Conditions |
|-----------|----------------------------------|-----------------|--------------------|-----|-------|--------------------------------------|------|-------|--|
| | | | Min | Typ | Max | Min | Max | | |
| V_{IH} | HIGH Level Input Voltage | 4.5 – 5.5 | 2.0 | | | 2.0 | | V | |
| V_{IL} | LOW Level Input Voltage | 4.5 – 5.5 | | | 0.8 | | 0.8 | V | |
| V_{OH} | HIGH Level Output Voltage | 4.5 | 4.4 | 4.5 | | 4.4 | | V | $V_{IN} = V_{IH}$ $I_{OH} = -50 \mu A$ |
| | | 4.5 | 3.94 | | | 3.80 | | V | $I_{OH} = -8 mA$ |
| V_{OL} | LOW Level Output Voltage | 4.5 | | 0.0 | 0.1 | | 0.1 | V | $V_{IN} = V_{IL}$ $I_{OL} = +50 \mu A$ |
| | | 4.5 | | | 0.36 | | 0.44 | V | $I_{OL} = +8 mA$ |
| I_{OZ} | 3-STATE Output Off-State Current | 5.5 | | | ±0.25 | | ±2.5 | μA | $V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = V_{CC}$ or GND |
| I_{IN} | Input Leakage Current | 0 – 5.5 | | | ±0.1 | | ±1.0 | μA | $V_{IN} = 5.5V$ or GND |
| I_{CC} | Quiescent Supply Current | 5.5 | | | 4.0 | | 40.0 | μA | $V_{IN} = V_{CC}$ or GND |
| I_{CCT} | Maximum I_{CC} /Input | 5.5 | | | 1.35 | | 1.50 | mA | $V_{IN} = 3.4V$ Other Inputs = V_{CC} or GND |
| I_{OFF} | Output Leakage Current | 0 | | | 0.5 | | 5.0 | μA | $V_{OUT} = 5.5V$ |

Noise Characteristics

| Symbol | Parameter | V _{CC} (V) | T _A = 25°C | | Units | Conditions |
|-------------------------------|--|------------------------|-----------------------|--------|-------|------------------------|
| | | | Typ | Limits | | |
| V _{OLP} (Note 7) | Quiet Output Maximum Dynamic V _{OL} | 5.0 | 1.2 | 1.6 | V | C _L = 50 pF |
| V _{OLV} (Note 7) | Quiet Output Minimum Dynamic V _{OL} | 5.0 | -1.2 | -1.6 | V | C _L = 50 pF |
| V _{IHD} (Note 7) | Minimum HIGH Level Dynamic Input Voltage | 5.0 | | 2.0 | V | C _L = 50 pF |
| V _{I LD} (Note 7) | Maximum HIGH Level Dynamic Input Voltage | 5.0 | | 0.8 | V | C _L = 50 pF |

Note 7: Parameter guaranteed by design.

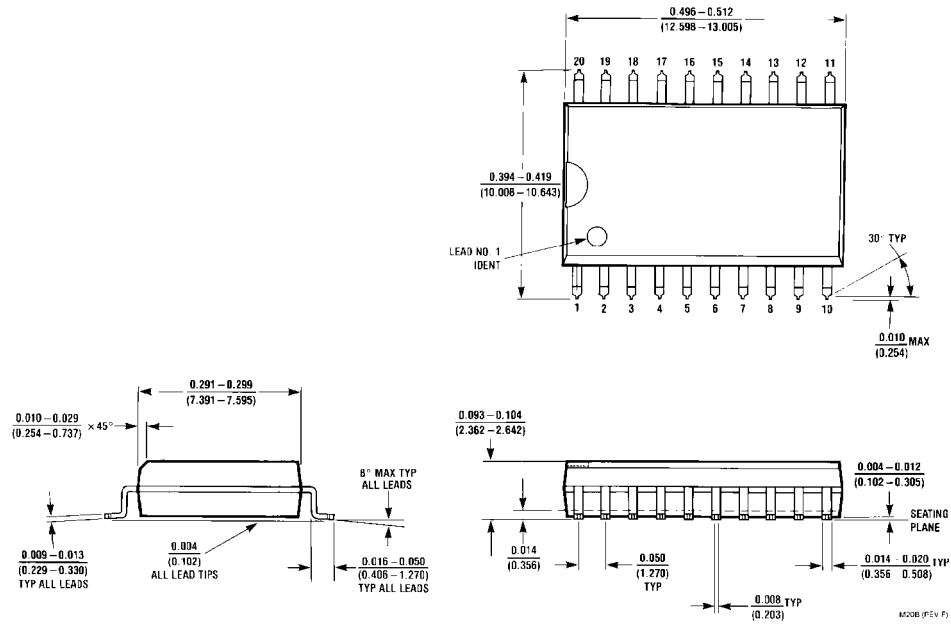
AC Electrical Characteristics

| Symbol | Parameter | V _{CC} (V) | T _A = 25°C | | | T _A = -40°C to +85°C | | Units | Conditions | |
|-------------------|-------------------------------|------------------------|-----------------------|-----|------|---------------------------------|------|-------|------------------------|------------------------|
| | | | Min | Typ | Max | Min | Max | | | |
| t _{PLH} | Propagation Delay | 5.0 ± 0.5 | | 5.0 | 6.9 | 1.0 | 8.0 | ns | | C _L = 15 pF |
| t _{PHL} | Time | | | 5.5 | 7.9 | 1.0 | 9.0 | | | C _L = 50 pF |
| t _{PZL} | 3-STATE Output | 5.0 ± 0.5 | | 8.3 | 11.3 | 1.0 | 13.0 | ns | R _L = 1 kΩ | C _L = 15 pF |
| t _{PZH} | Enable Time | | | 8.8 | 12.3 | 1.0 | 14.0 | | | C _L = 50 pF |
| t _{PLZ} | 3-STATE Output | 5.0 ± 0.5 | | 9.4 | 11.9 | 1.0 | 13.5 | ns | R _L = 1 kΩ | C _L = 50 pF |
| t _{PHZ} | Disable Time | | | | | | | | | |
| t _{OSLH} | Output to Output Skew | 5.0 ± 0.5 | | | 1.0 | | 1.0 | ns | (Note 8) | C _L = 50 pF |
| t _{OSHL} | | | | | | | | | | |
| C _{IN} | Input Capacitance | | | 4 | 10 | | 10 | pF | V _{CC} = Open | |
| C _{OUT} | Output Capacitance | | | 9 | | | | pF | V _{CC} = 5.0V | |
| C _{PD} | Power Dissipation Capacitance | | | 19 | | | | pF | (Note 9) | |

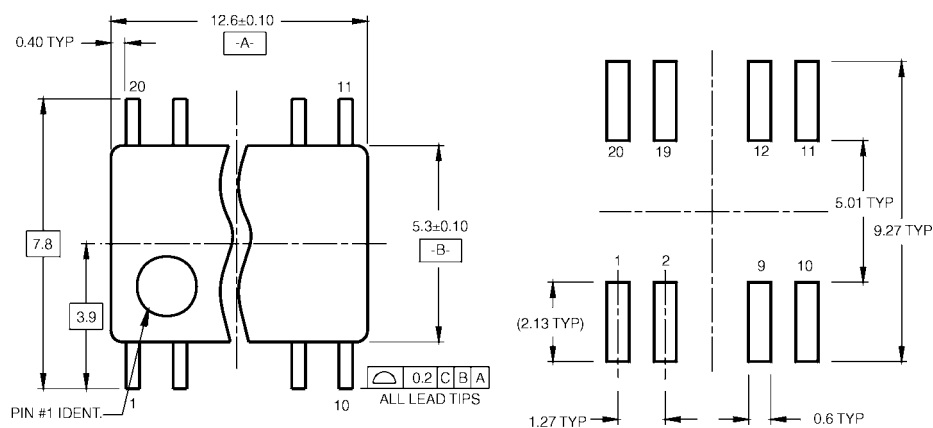
Note 8: Parameter guaranteed by design. t_{OSLH} = |t_{PLHmax} - t_{PLHmin}|; t_{OSHL} = |t_{PHLmax} - t_{PHLmin}|.

Note 9: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I_{CC} (OPR.) = C_{PD} * V_{CC} * f_{IN} + I_{CC}/8 (per bit).

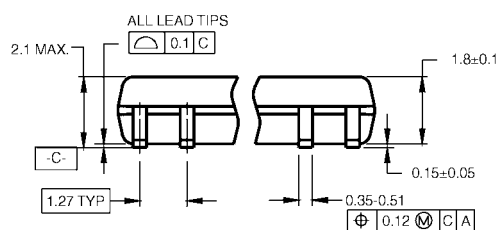
Physical Dimensions inches (millimeters) unless otherwise noted



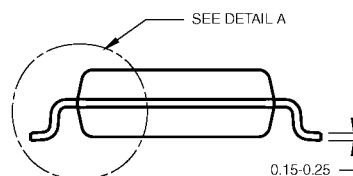
20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
Package Number M20B

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)


LAND PATTERN RECOMMENDATION



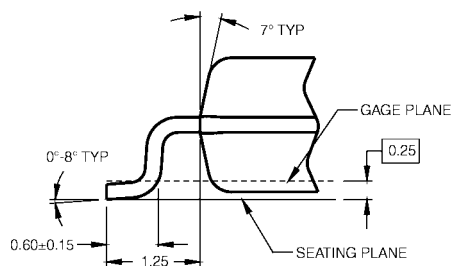
DIMENSIONS ARE IN MILLIMETERS



NOTES:

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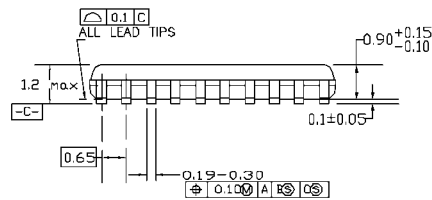
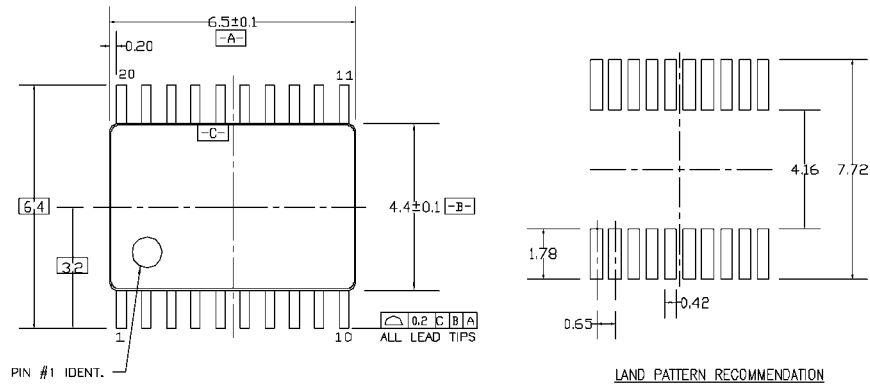
M20DRevB1



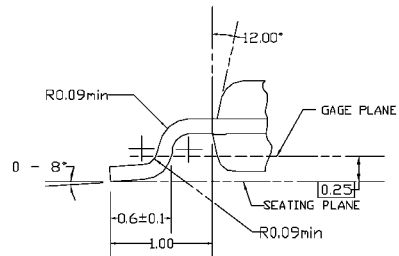
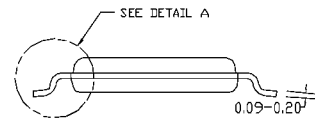
DETAIL A

**Pb-Free 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M20D**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



DIMENSIONS ARE IN MILLIMETERS



DETAIL A

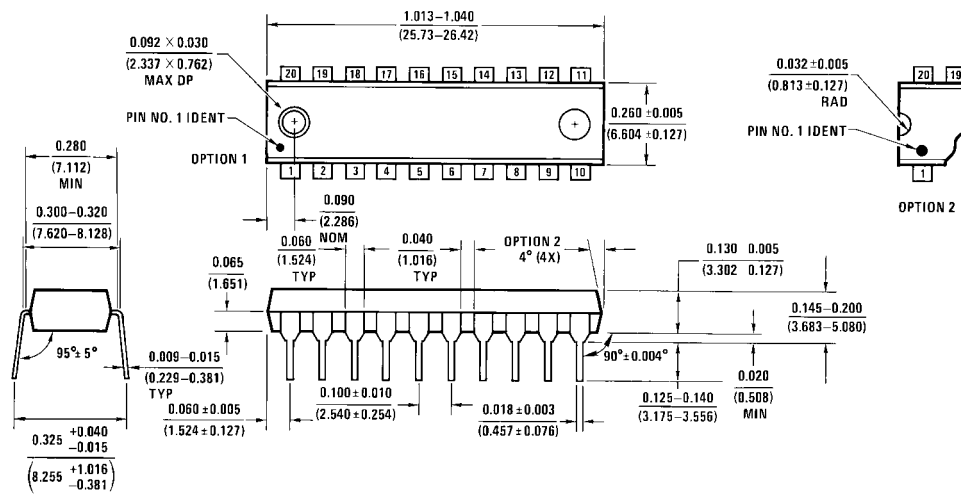
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- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MTC20REV D1

**20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
Package Number MTC20**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
Package Number N20A

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